April 2000



LM66 Dual Output Internally Preset Thermostat General Description Features

The LM66 is a precision low power thermostat. Two stable temperature trip points (V_{T1} and V_{T2}) are generated by dividing down the LM66 1.250V bandgap voltage reference using a resistors divider network. The LM66 has two digital outputs. OUT1 goes LOW when the temperature exceeds T1 and goes HIGH when the the temperature goes below (T1–T_{HYST}). Similarly, OUT2 goes LOW when the temperature goes below (T2–T_{HYST}). T_{HYST} is an internally set 5°C typical hysteresis.

The LM66 is currently available in an 8-lead small outline package.

Applications

- Microprocessor Thermal Management
- Appliances
- Portable Battery Powered 3.0V or 5V Systems
- Fan Control

OUT2

OUT 1

- Industrial Process Control
- HVAC Systems
- Remote Temperature Sensing
- Electronic System Protection

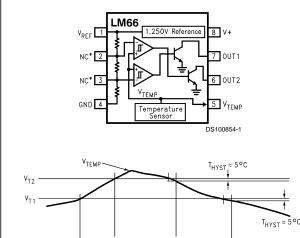
- Digital outputs support TTL logic levels
- Internal temperature sensor
- 2 internal comparators with hysteresis
- Internal voltage reference
- Currently available in 8-pin SO plastic package

Key Specifications

Power Supply Voltage	2.7V to 10V
Power Supply Current	250 µA (max)
■ V _{REF}	1.250V ±1.4%
	(max)
 Hysteresis Temperature 	5°C
Internal Temperature Sensor	(+6.20 mV/°C x T)
Output Voltage	+400mV
Temperature Trip Point	±3°C (max)
Accuracy	
T1 set point	+73°C
T2 set point	+82°C

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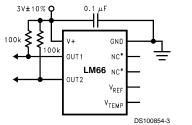
Simplified Block Diagram and Connection Diagram



Ordering Information

TABLE 1.					
Order Number	LM66CIM-	LM66CIMX-			
	RLSKB	RLSKB			
NS Tackage Number	M08A	M08A			
Transport Media	Bulk Rail	2500 Units Tape & Reel			

Typical Application



DS100854-2

Absolute Maximum Ratings (Note 1)

Absolute Maximum Rating	S (Note 1)	Vapor Phase (60 seconds)	215°C
Input Voltage	12V	Infrared (15 seconds)	220°C
Input Current at any pin (Note 2)	5 mA	Storage Temperature	–65°C to + 150°C
Package Input Current (Note 2) Package Dissipation at $T_{A} = 25^{\circ}C$	20 mA	Operating Ratings (No	ote 1)
(Note 3)	900 mW	Operating Temperature Range	$T_{MIN} \le T_A \le T_{MAX}$
ESD Susceptibility (Note 4)		LM66CIM	-40°C $\le T_A \le +125°$ C
Human Body Model	1000V	Positive Supply Voltage (V ⁺)	+2.7V to +10V
Machine Model	200V	Maximum V _{OUT1} and V _{OUT2}	+10V
Soldering Information SO Package (Note 5) :		0011 00012	

LM66 Electrical Characteristics

The following specifications apply for V⁺ = 2.7 V_{DC}, and V_{REF} load current = 0 μ A unless otherwise specified. Boldface limits apply for T_A = T_J = T_{MIN} to T_{MAX}; all other limits T_A = T_J = 25°C unless otherwise specified.

Symbol	Parameter	Conditions	Typical (Note 6)	LM66CIM Limits (Note 7)	Units (Limits)
Temperatur	e Sensor			(
	Trip Point Accuracy (Includes				
	V _{REF} , Comparator Offset, and	+25°C ≤ T _A ≤ +85°C		±3	°C (max)
	Temperature Sensitivity errors)				
	Trip Point Hysteresis	T _A = +73°C	6	4.5	°C (min)
				7.5	°C (max)
		$T_A = +82^{\circ}C$	6	4.5	°C (min)
				7.5	°C (max)
	Internal Temperature Sensitivity		+6.20		mV/°C
	Temperature Sensitivity Error	$+25^{\circ}C \le T_A \le +85^{\circ}C$		±3	°C (max)
		$-25^{\circ}C \le T_A \le +125^{\circ}C$		±4	°C (max)
		$-40^{\circ}C \le T_A \le -25^{\circ}C$		±5	°C (max)
	Output Impedance	$-1 \ \mu A \le I_L \le +40 \ \mu A$		1500	Ω (max)
	Line Regulation	$+3.0V \le V^+ \le +10V$,		±0.36	mV/V (max
		$+25^{\circ}C \le T_A \le +85^{\circ}C$			
		$+3.0V \le V^+ \le +10V$,		±0.61	mV/V (max
		$-40^{\circ}C \le T_A < 25^{\circ}C$			
		$+2.7V \le V^+ \le +3.3V$		±2.3	mV (max)
/ _{REF} Output	1	-	1		
/ _{REF}	V _{REF} Nominal		1.250V		V
	V _{REF} Error			±1.4	% (max)
				±17.5	mV (max)
$\Delta V_{REF} / \Delta V^+$	Line Regulation	$+3.0V \le V^+ \le +10V$	0.13	0.21	mV/V (max
		$+2.7V \le V^+ \le +3.3V$	0.15	1.5	mV (max)

LM66 Electrical Characteristics

The following specifications apply for V⁺ = 2.7 V_{DC}, and V_{REF} load current = 50 μ A unless otherwise specified. Boldface limits apply for T_A = T_J = T_{MIN} to T_{MAX}; all other limits T_A = T_J = 25°C unless otherwise specified.

Symbol Parameter		Conditions	Typical	Limits	Units
			(Note 6)	(Note 7)	(Limits)
V ⁺ Power Sup	ply				÷
ls	Supply Current	V ⁺ = +10V		250	μA (max)
		$V^{+} = +2.7V$		250	μA (max)
Digital Output	(s)		•		
I _{OUT("1")}	Logical "1" Output Leakage Current	V ⁺ = +5.0V		1	μA (max)
V _{OUT("0")}	Logical "0" Output Voltage	Ι _{ΟUT} = +50 μΑ		0.4	V (max)

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Note 2: When the input voltage (V₁) at any pin exceeds the power supply (V₁ < GND or V₁ > V⁺), the current at that pin should be limited to 5 mA. The 20 mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 5 mA to four.

Note 3: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{Jmax} (maximum junction temperature), θ_{JA} (junction to ambient thermal resistance) and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_D = (T_{Jmax} - T_A)/\theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower. For this device, $T_{Jmax} = 125$ °C. For this device the typical thermal resistance (θ_{JA}) of the different package types when board mounted follow:

Package Type	$_{AL}\theta$
M08A	110°C/W

Note 4: The human body model is a 100 pF capacitor discharge through a 1.5 k Ω resistor into each pin. The machine model is a 200 pF capacitor discharged directly into each pin.

Note 5: See AN450 "Surface Mounting Methods and Their Effects on Product Reliability" or the section titled "Surface Mount" found in any post 1986 National Semiconductor Linear Data Book for other methods of soldering surface mount devices.

Note 6: Typicals are at $T_J = T_A = 25^{\circ}C$ and represent most likely parametric norm.

Note 7: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

Part Number Template The series of digits labled vw xy z in the part number LM66CIM-vw xy z, describe the set points and the function of OUT1 and OUT2 as follows:

The place holders v w describe the set point of T1 as shown in the following table.

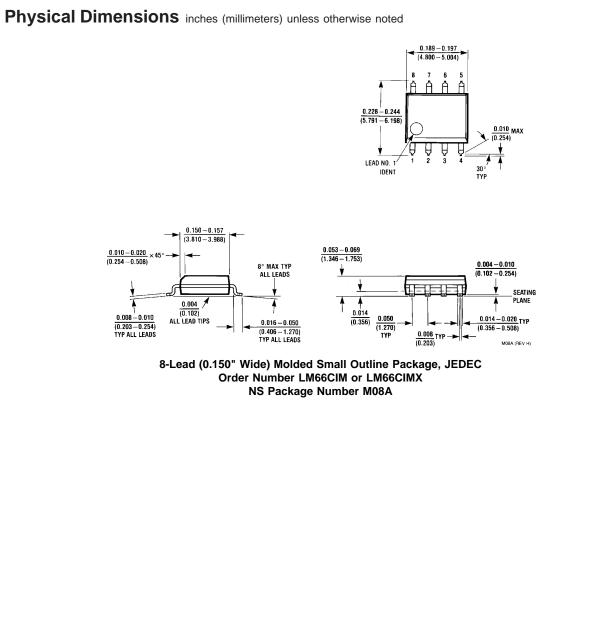
The place holders xy describe the set point of T2 as shown in the following table. z=0 (Other assignments are reserved.) For example the part number LM66CIM-RLSKB has: T1 = 73°C, T2 = 82°C, OUT1 and OUT2 set as active-low open-collector outputs with OUT1 mapped to pin 7 and OUT2 mapped to pin 6.

v, w, x and y	Temperature (°C)
В	-5
С	-4
D	-3
F	-2
G	-1
Н	-0
J	1
К	2
L	3
N	4

v, w, x and y	Temperature (°C)
Р	5
Q	6
R	7
S	8
Т	9
V	10
Х	11
Y	12
Z	13

The value of z describes the assignment/function of OUT1 and OUT2 as shown in the following table:

Active Low//High	Open Collector/ Totem Pole	Mapping	Value of z	Function of OUT1 and OUT2
0	0	0	В	Active-Low, Open-Collector, OUT1 mapped to pin 7, OUT2 mapped to pin 6
0	0	1	С	Active-Low, Open-Collector, OUT1 mapped to pin 6, OUT2 mapped to pin 7
0	1	0	D	Active-Low, Totem Pole, OUT1 mapped to pin 7, OUT2 mapped to pin 6
0	1	1	F	Active-Low, Totem Pole, OUT1 mapped to pin 6, OUT2 mapped to pin 7
1	0	0	G	Active-High, Open-Collector, OUT1 mapped to pin 7, OUT2 mapped to pin 6
1	0	1	Н	Active-High, Open-Collector, OUT1 mapped to pin 6, OUT2 mapped to pin 7
1	1	0	J	Active-High, Totem Pole, OUT1 mapped to pin 7, OUT2 mapped to pin 6
1	1	1	K	Active-High, Totem Pole, OUT1 mapped to pin 6, OUT2 mapped to pin 7



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